



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Attorney Docket No.: 040679/0439

In re patent application of

Haruhiko MURATA et al.

Serial No.: 08/825,400

Group Art Unit: 2827

Filed: March 28, 1997

Examiner: K. Cuneo

For: IMPROVEMENT IN OR RELATING TO CIRCUIT BOARD HAVING SOLDER  
BUMPS

7/21/02  
8/23/02  
Harlan

RESPONSE TO RESTRICTION REQUIREMENT

Commissioner for Patents  
Washington, D.C. 20231

Sir:

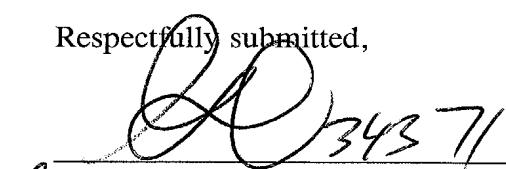
In response to the Office Action dated July 16, 2002, Applicants hereby elect the claims of Group I, claims 13-15, 17-23 and 29-30, for prosecution in the subject application.

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Upon allowance of the elected claims, Applicants will be permitted to request rejoinder in accordance with MPEP 821.04 and *In re Ochiai*, 71 F.3d 1565 USPQ2d 1127 (Fed.Cir. 1995) of method claims 24-28 and 31-33.

Receipt of the initial Office Action on the merits is awaited.

Respectfully submitted,

  
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